



RAYSTAR

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RFF700A2-AIH-DNL

SPECIFICATION

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

Release DATE:

TFT Display Inspection Specification: <https://www.raystar-optronics.com/download/products.htm>

Precaution in use of TFT module: <https://www.raystar-optronics.com/download/declaration.htm>

Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2022/11/01		First issue

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1.Module Classification Information

R	F	F	70	0A2	-	A	I	H	-	D	N	L
1	2	3	4	5	-	6	7	8	-	9	10	11

Item	Description			
1	R : Raystar Optronics Inc.			
2	Display Type : F→TFT Type, J→ Custom TFT			
3	Solution: A: 128x160 B:320x234 C:320x240 D:480x234 E:480x272 F:800x480 G:640x480 H:1024x600 I:320x480 J:240x320 K:1280x800 L:240x400 M:1024x768 N:128x128 O:480x800 P:640x320 Q:800x600 S:480x128 T:800x320			
4	Display Size : 7.0” TFT			
5	Version Code: V: Raspberry pi 3B+ X:Raspberry pi			
6	Model Type: A : TFT LCD E : TFT+FR+CONTROL BOARD J : TFT+FR+A/D BOARD N : TFT+FR+A/D BOARD+CONTROL BOARD S : TFT+FR+POWER BOARD (DC TO DC)		6 : TFT+FR H : TFT+D/V BOARD I : TFT+FR+D/V BOARD B : TFT+POWER BD 1 : TFT+CONTROL BOARD	
7	Polarizer Type, Temperature range, View direction	I→Transmissive, W. T, 6:00 ; C→Transmissive, N. T, 6:00 L→Transmissive, W.T,12:00 ; F→Transmissive, N.T,12:00 Y→Transmissive,W.T, IPS TFT ; W→Transmissive, Super W.T, IPS TFT A→Transmissive, N.T, IPS TFT V→Transmissive, Super W.T, VA TFT Z→Transmissive, W.T, O-TFT R→Transmissive, Super W.T, O-TFT N→Transmissive, Super W.T, 6:00; Q→Transmissive, Super W.T, 12:00		
8	Backlight	W : LED, White	H : LED, High Light White	
		F : CCFL, White		
9	Driver Method	D: Digital A: Analog L : LVDS M:MIPI		
10	Interface	N : without control board A : 8Bit B : 16Bit S:SPI Interface R: RS232 U:USB I: I2C H: HDMI		
11	TS	N : Without TS S : resistive touch panel C : capacitive touch panel capacitive touch panel (G-F-F) G : capacitive touch panel(G-G) B: CTP+GG+USB L: CTP+GG Hovering Touch		

2.Summary

TFT 7.0" is a TN transmissive type color active matrix TFT liquid crystal display that uses amorphous silicon TFT as switching devices. This module is composed of a TFT_LCD module, it is usually designed for industrial application and this module follows RoHS.

RAYSTAR OPTRONICS

3.General Specifications

- Size: 7.0 inch
- Dot Matrix: 800 x RGB x 480 (TFT) dots
- Module dimension: 165 x 100.0x 8.15 mm
- Active area: 154.08 x 85.92 mm
- Pixel Pitch: 0.1926 X 0.179 mm
- LCD type: TFT, Normally White, Transmissive
- View Direction: 12 o'clock
- Gray Scale Inversion Direction: 6 o'clock
- Aspect Ratio: 16:9
- Backlight Type: LED ,Normally White
- TFT Interface: 24-bit RGB
- Color arrangement: RGB-STRIPLE
- TFT Driver IC: Source IC: ST-5623D, Gate IC: ST5091D
- CTP Active Area: 145.22mm*77.19mm(Lens va One-sided retraction 5mm)
- CTP IC: MXT874U or equivalent
- CTP Interface: I2C
- CTP FW Version: 0x8CAB7A
- CTP Resolution: 800*480
- With /Without TP: With CTP
- Surface: Glare

*Color tone slight changed by temperature and driving voltage.

4.Interface

4.1. LCM PIN Definition

Pin	Symbol	Function	Remark
1	LED+	Power supply for backlight	
2	LED+	Power supply for backlight	
3	LED-	Backlight ground	
4	LED-	Backlight ground	
5	GND	Power ground	
6	VCOM	Common voltage	
7	VCC	Power for Digital Circuit	
8	MODE	DE/SYNC mode select	Note 1
9	DE	Data Input Enable	
10	VS	Vertical Sync Input	
11	HS	Horizontal Sync Input	
12	B7	Blue data(MSB)	
13	B6	Blue data	
14	B5	Blue data	
15	B4	Blue data	
16	B3	Blue data	
17	B2	Blue data	
18	B1	Blue data	Note 2
19	B0	Blue data(LSB)	Note 2
20	G7	Green data(MSB)	
21	G6	Green data	
22	G5	Green data	
23	G4	Green data	
24	G3	Green data	
25	G2	Green data	
26	G1	Green data	Note 2
27	G0	Green data(LSB)	Note 2
28	R7	Red data(MSB)	
29	R6	Red data	
30	R5	Red data	
31	R4	Red data	

32	R3	Red data	
33	R2	Red data	
34	R1	Red data	Note 2
35	R0	Red data(LSB)	Note 2
36	GND	Power Ground	
37	DCLK	Sample clock (CLK)	Note 3
38	GND	Power Ground	
39	L/R	Left / right selection	Note 4
40	U/D	Up/down selection	Note 5
41	VGH	Gate ON Voltage	
42	VGL	Gate OFF Voltage	
43	AVDD	Power for Analog Circuit	
44	RESET	Global reset pin.	Note 6
45	NC	No connection	
46	VCOM	Common Voltage	
47	DITHB	Dithering function	Note 7
48	GND	Power Ground	
49	NC	No connection	
50	NC	No connection	

I: input, O: output, P: Power

Note 1: When select DE mode, MODE="1", VS and HS must pull high.

When select SYNC mode, MODE="0", DE must be grounded.

Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

Note 3: Data shall be latched at the falling edge of DCLK.

Note 4: Source Right or Left sequence control

L/R="L", shift left: last data=S1←S2←S3...←S1200=first data

L/R="H", shift left: last data=S1←S2←S3...←S1200=last data

Note 5: Gate Up or Down scan control

U/D="L", STV2 output vertical start pulse and UD pin output logical "0" to gate driver

U/D="H", STV1 output vertical start pulse and UD pin output logical "1" to gate driver

Note 6: Global reset pin. Active low to enter reset state . Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note 7: Dithering function enable control, normally pull high.

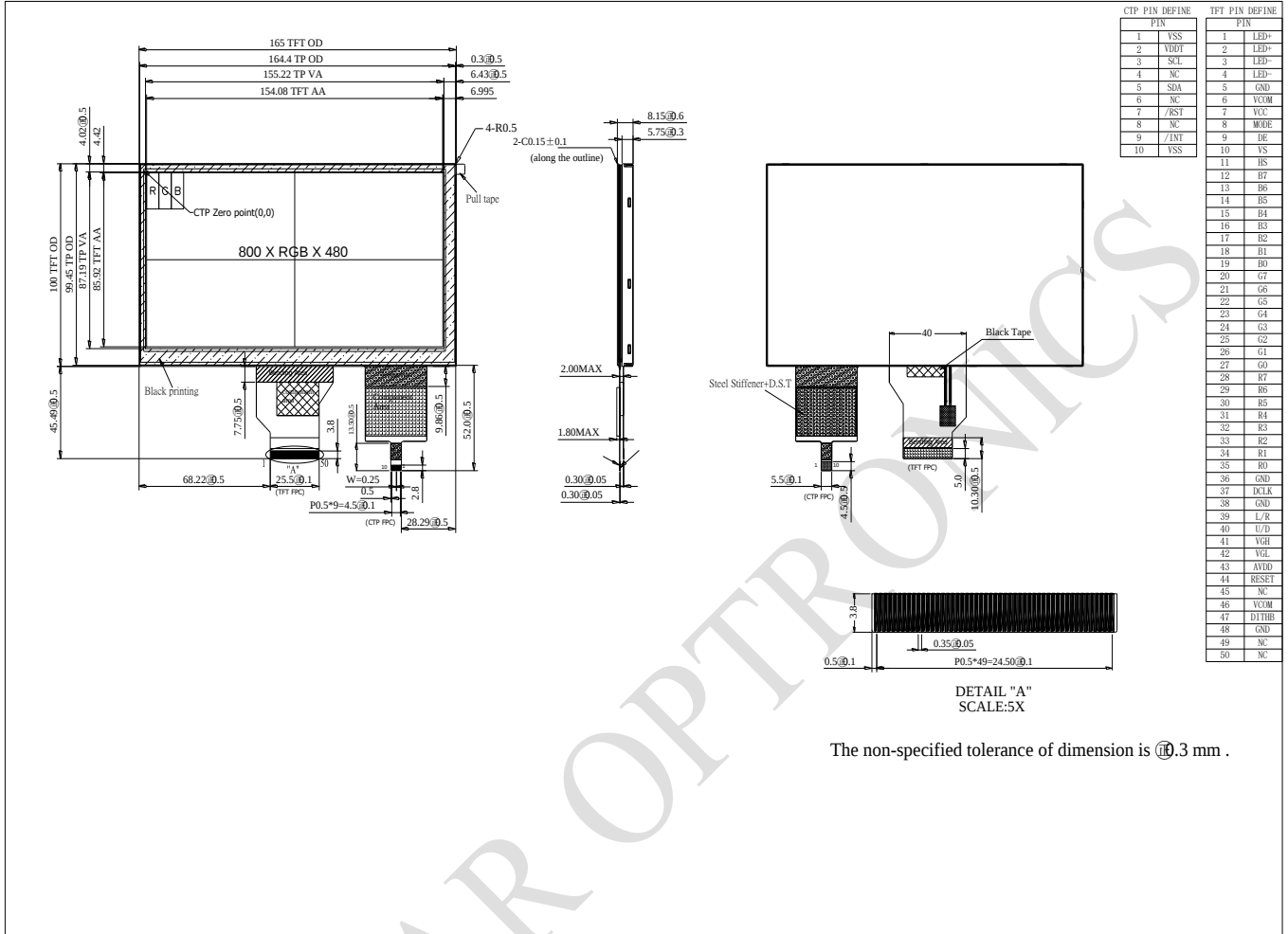
When DITHB="1", Disable internal dithering function,

When DITHB="0", Enable internal dithering function,

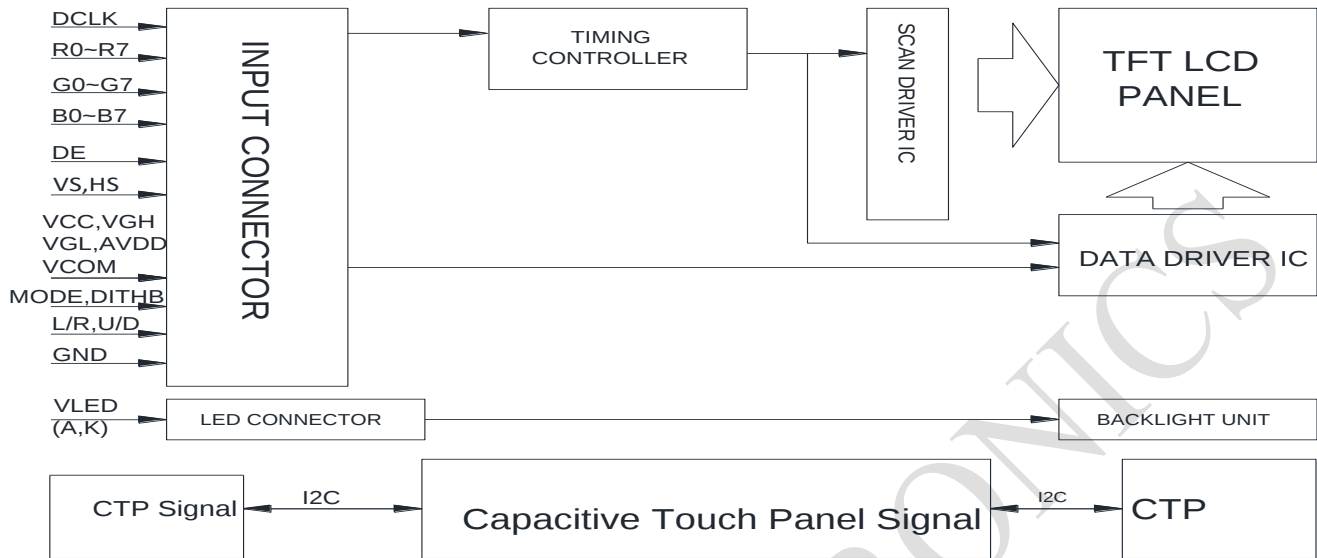
4.2. CTP PIN Definition

Pin	Symbol	Function	Remark
1	VSS	Ground for analog circuit	
2	VDDT	Power Supply : +3.3V	
3	SCL	I2C clock input	
4	NC	No connect	
5	SDA	I2C data input and output	
6	NC	No connect	
7	RST	External Reset, Low is active	
8	NC	No connect	
9	INT	External interrupt to the host	
10	VSS	Ground for analog circuit	

5. Contour Drawing



6. Block Diagram



7. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

- Temp. ≤ 60°C, 90% RH MAX. Temp. > 60°C, Absolute humidity shall be less than 90% RH at 60°C

8. Electrical Characteristics

8.1. Operating conditions

Item	Symbol	Min	Typ	Max	Unit	Remark
Supply Voltage For Logic	VCC	3.0	3.3	3.6	V	Note 2
Supply CTP	VDDT	3.0	3.3	3.6	V	
	I _{CTP}	—	15	25	mA	
Power voltage	AVDD	10.2	10.4	10.6	V	
Power Supply For Current	VCC = 3.3V	-	10	15	mA	-
Power voltage	VGH	14.5	15.0	15.5	V	-
Power voltage	VGL	-10.5	-10	-9.5	V	-
Input signal voltage	VCOM	3.54	4.04	4.54	V	Note 4

Note: (1) Vcom must be adjusted to optimize display quality: cross-talk, contrast ratio and etc.

(2) VGH is TFT gate operating voltage

(3) VGL is TFT gate operating voltage

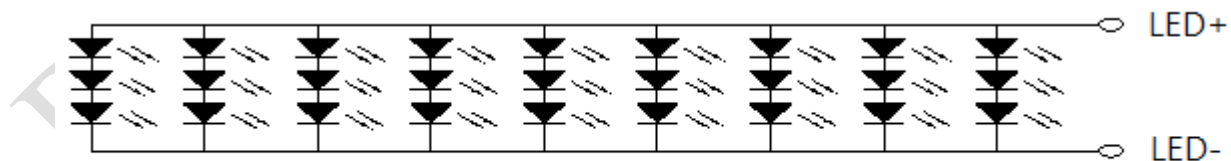
(4) Environmental condition: 25±5

(5) Reference waveform for panel light on is as below: (release after sample output)

8.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current	-	-	270	-	mA	-
Power Consumption	-	2268	2430	2592	mW	-
LED voltage	LED+	8.4	9.0	9.6	V	Note 1
LED Life Time	-	-	50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Backlight LED Circuit

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

9.DC Characteristics

Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3VCC	V	
High level input voltage	V_{IH}	0.7VCC	-	VCC	V	

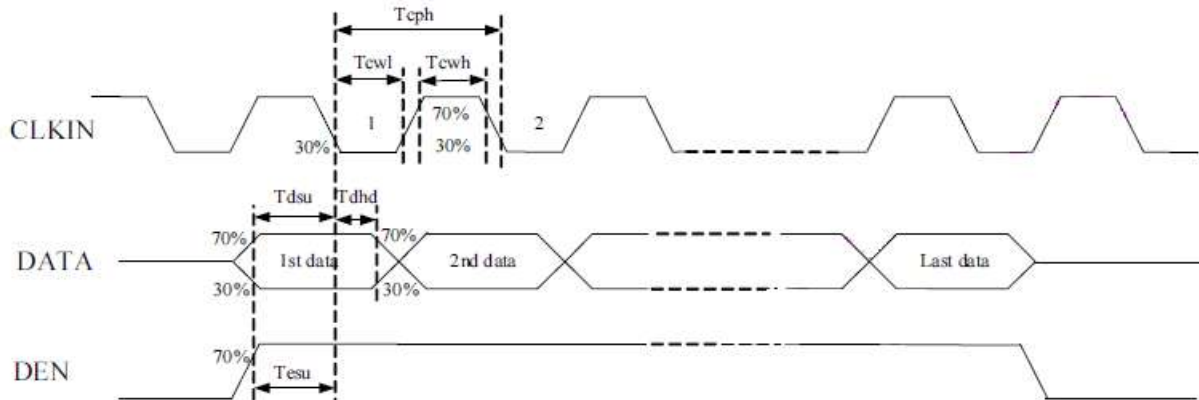
10.AC CHARATERISTICS

10.1. Parallel DE mode RGB input timing table

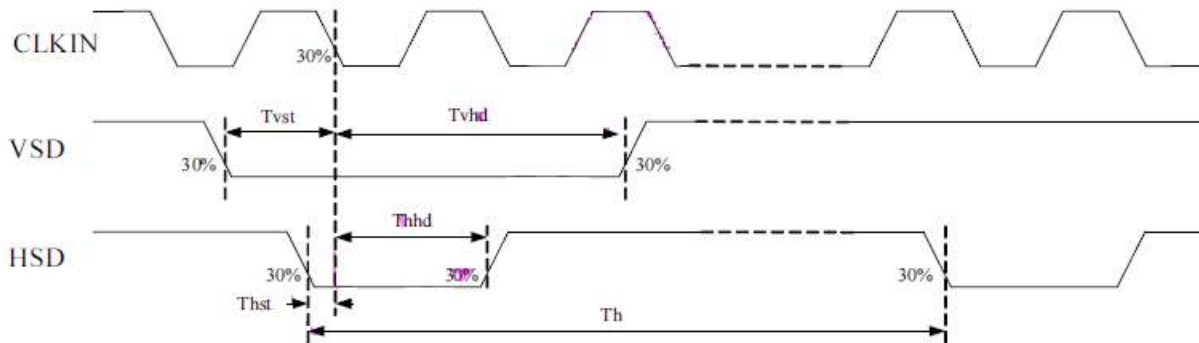
Signal	Symbol	Min	Typ	Max	Unit	Conditions
VDD Power on Slew Rate	TPOR	-	-	20	ms	From 0V to 90% VDD
RSTB pulse width	TRST	10	-	-	us	Clkin=50MHz
CLKIN cycle time	Tcph	20	-	-	ns	
CLKIN pulse duty	Tcwh	40	50	60	%	
VSD setup time	Tvst	8	-	-	ns	
VSD hold time	Tvhd	8	-	-	ns	
HSD setup time	Thst	8	-	-	ns	
HSD hold time	Thhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	D[7:0], D1[7:0], D2[7:0] to clkin
Date hold time	Tdhd	8	-	-	ns	D[7:0], D1[7:0], D2[7:0] to clkin
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
Output stable time	Tsst	-	-	6	us	10% to 90% target voltage. CL=120pF, R=10Kohm
CLKIN Frequency	Fclk	-	40	50	MHz	VDD=3.0V~3.6V
CLKIN Cycle Time	Tclk	20	25	-	ns	
CLKIN Pulse Duty	Tcwh	40	50	60	%	Tclk
Time from HSD to Source Output	Thso	-	20	-	CLKIN	
Time from HSD to LD	Thld	-	20	-	CLKIN	
Time from HSD to STV	Thstv	-	2	-	CLKIN	
Time from HSD to CKV	Thckv	-	20	-	CLKIN	
Time from HSD to OEV	Thoev	-	4	-	CLKIN	
LD pulse width	Twld	-	10	-	CLKIN	
CKV pulse width	Twckv	-	66	-	CLKIN	
OEV pulse width	Twoev	-	74	-	CLKIN	

10.2. Input Clock and Data Timing Diagram

DE MODE(CLKPOL="0")



SYNC MODE



10.3. Timing

Horizontal input timing

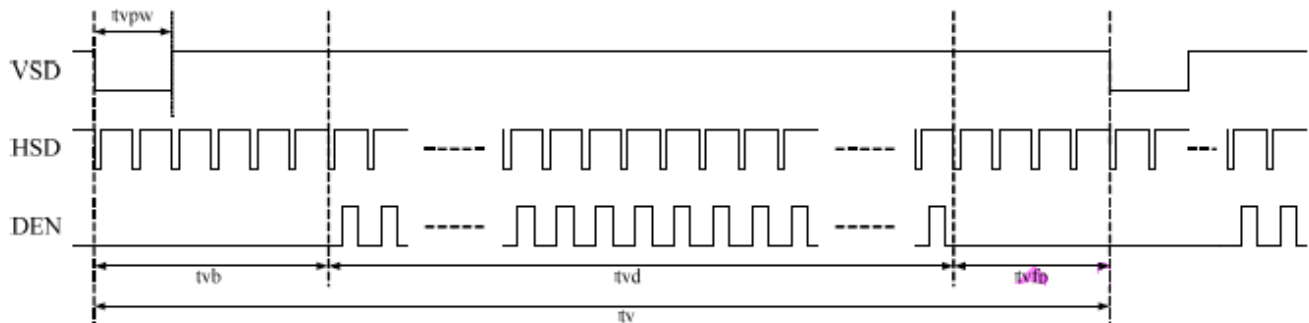
Item		Symbol	Values			Unit
Horizontal display area		thd	800			DCLK
DCLK frequency		fclk	Min.	Typ.	Max.	
			-	33.3	50	MHz
1 Horizontal Line		th	862	1056	1200	DCLK
HSD pulse width	Min.	thpw	1			
	Typ.		-			
	Max.		40			
HSD Blanking		thb	46	46	46	
HSD Front Porch		thfp	16	210	354	

Vertical input timing

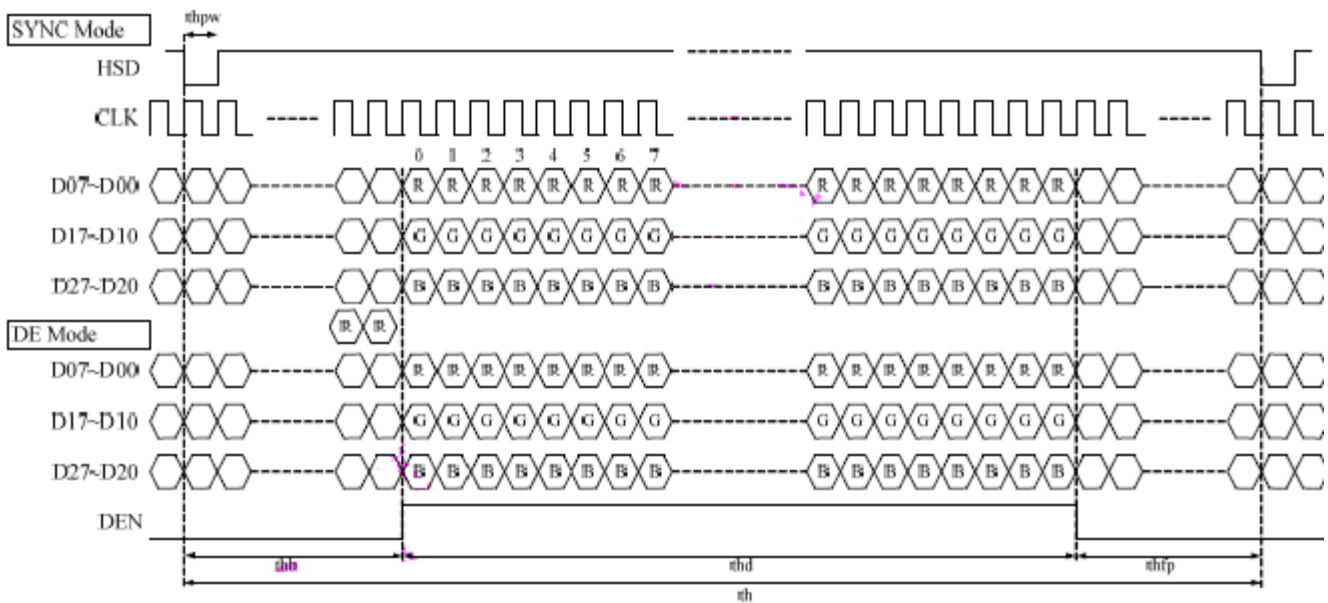
Item	Symbol	Values			Unit
		Min	Typ.	Max.	
Vertical display area	tv _d	480			H
VSD period time	tv	510	525	650	H
VSD pulse width	tv _{pw}	1	-	20	H
VSD Blanking	tv _b	23	23	23	H
VSD Front Porch	tv _{fp}	7	22	147	H

10.4. Data Input Format

Vertical input timing



Horizontal input timing



11. Optical Characteristics

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr+ Tf	$\theta=0^{\circ}$ 、 $\Phi=0^{\circ}$	-	25	50	.ms	Note 3
Contrast ratio		CR	At optimized viewing angle	500	800	-	-	Note 4
Color Chromaticity	White	Wx	$\theta=0^{\circ}$ 、 $\Phi=0$	0.26	0.31	0.36	-	Note 2,5,6
		Wy		0.28	0.33	0.38	-	
Viewing angle (Gray Scale Inversion Direction)	Hor.	ΘR	$CR \geq 10$	60	70	-	Deg.	Note 1
		ΘL		60	70	-		
	Ver.	ΦT		50	60	-		
		ΦB		60	70	-		
Brightness		-	-	600	700	-	cd/m ²	Center of display
Uniformity		(U)	-	70	-	-	%	Note 5

Ta=25±2℃

Note 1: Definition of viewing angle range

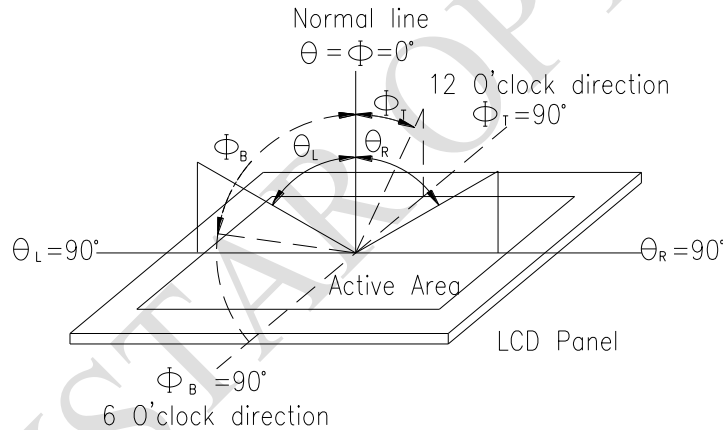


Fig. 11.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

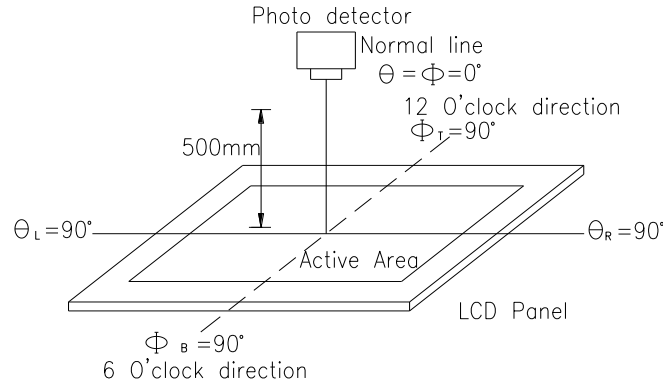
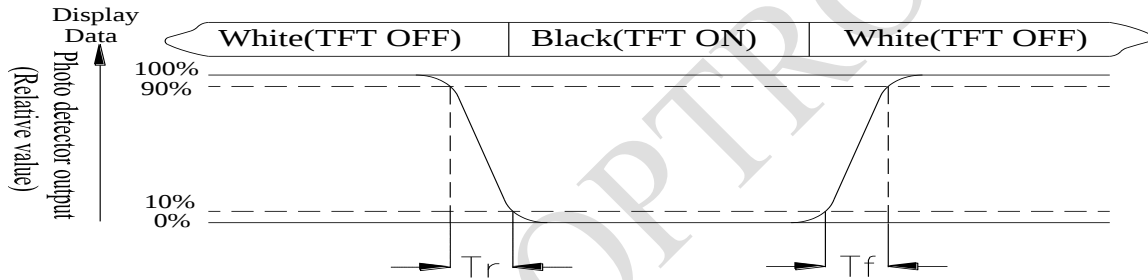


Fig. 11.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = $L_{min}/L_{max} \times 100\%$

L = Active area length

W = Active area width

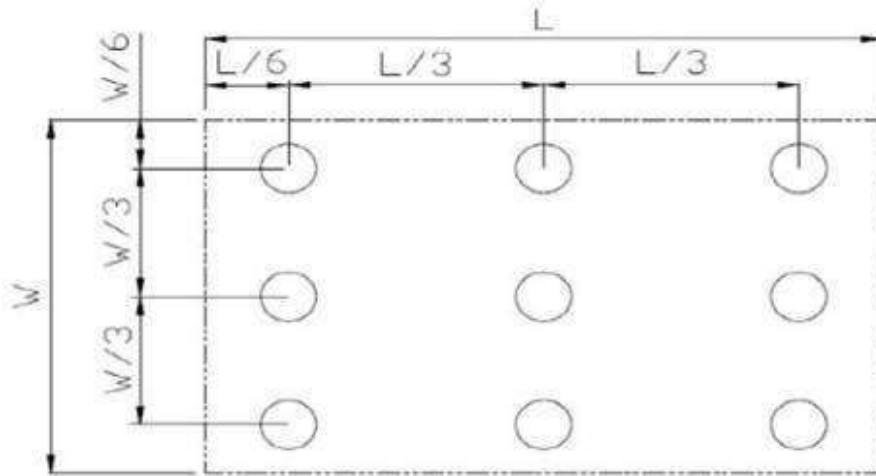


Fig11.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

12. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Contact ±8KV Air ±8KV 10 times	4

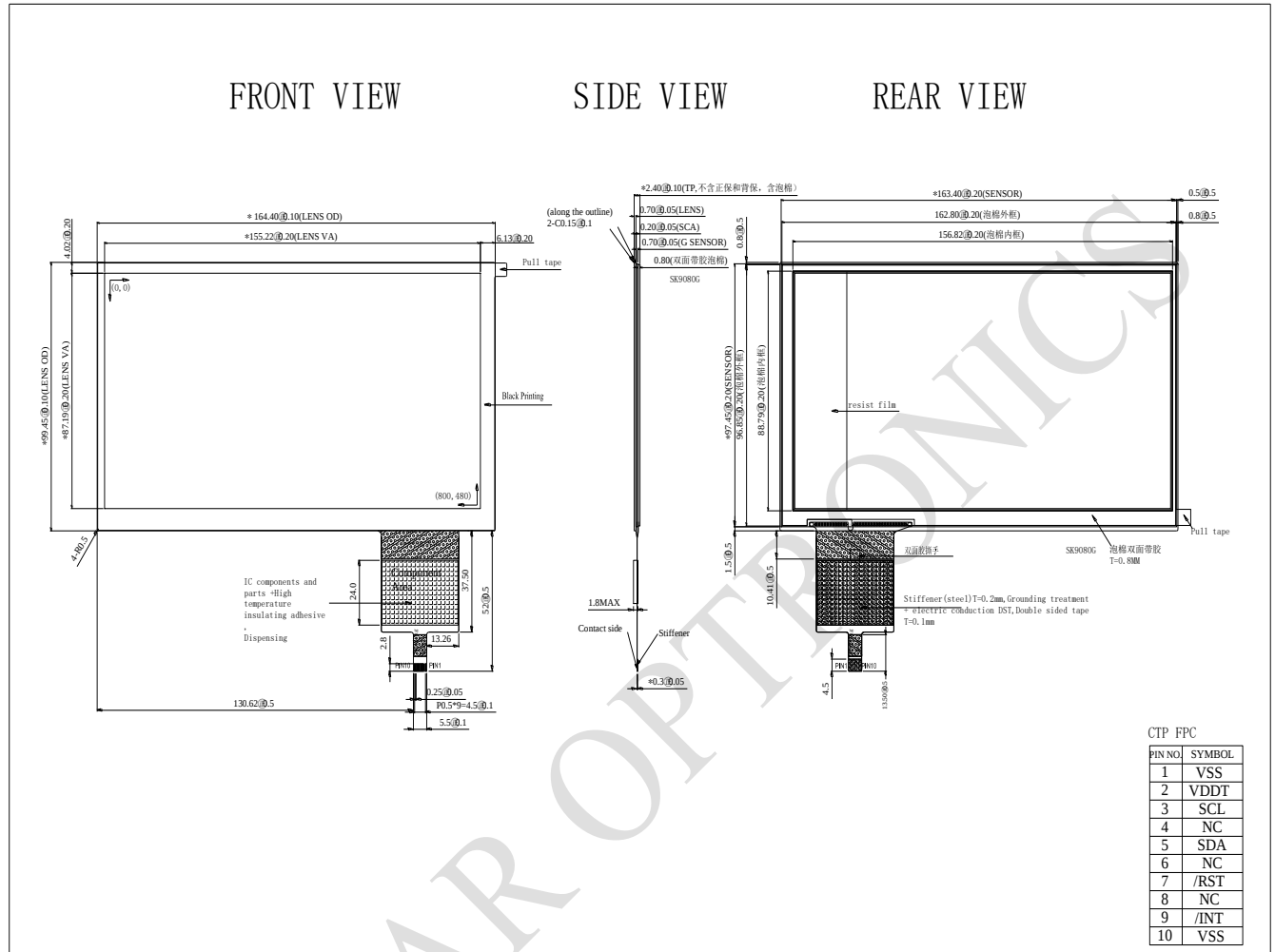
Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Note4: Some performance degradation allowed. Need Power off self-recoverable.
No hardware failure

13.Touch Panel Information



LCM Sample Estimate Feedback Sheet

Module Number : _____

1 、 Panel Specification :

1. Panel Type :	☐ Pass	☐ NG , _____
2. View Direction :	☐ Pass	☐ NG , _____
3. Numbers of Dots :	☐ Pass	☐ NG , _____
4. View Area :	☐ Pass	☐ NG , _____
5. Active Area :	☐ Pass	☐ NG , _____
6. Operating Temperature :	☐ Pass	☐ NG , _____
7. Storage Temperature :	☐ Pass	☐ NG , _____
8. Others : _____		

2 、 Mechanical Specification :

1. PCB Size :	☐ Pass	☐ NG , _____
2. Frame Size :	☐ Pass	☐ NG , _____
3. Material of Frame :	☐ Pass	☐ NG , _____
4. Connector Position :	☐ Pass	☐ NG , _____
5. Fix Hole Position :	☐ Pass	☐ NG , _____
6. Backlight Position :	☐ Pass	☐ NG , _____
7. Thickness of PCB :	☐ Pass	☐ NG , _____
8. Height of Frame to PCB :	☐ Pass	☐ NG , _____
9. Height of Module :	☐ Pass	☐ NG , _____
10. Others :	☐ Pass	☐ NG , _____

3 、 Relative Hole Size :

1. Pitch of Connector :	☐ Pass	☐ NG , _____
2. Hole size of Connector :	☐ Pass	☐ NG , _____
3. Mounting Hole size :	☐ Pass	☐ NG , _____
4. Mounting Hole Type :	☐ Pass	☐ NG , _____
5. Others :	☐ Pass	☐ NG , _____

4 、 Backlight Specification :

1. B/L Type :	☐ Pass	☐ NG , _____
2. B/L Color :	☐ Pass	☐ NG , _____
3. B/L Driving Voltage (Reference for LED Type) : ☐ Pass ☐ NG , _____		
4. B/L Driving Current :	☐ Pass	☐ NG , _____
5. Brightness of B/L :	☐ Pass	☐ NG , _____
6. B/L Solder Method :	☐ Pass	☐ NG , _____
7. Others :	☐ Pass	☐ NG , _____

>> Go to page 2 <<

Module Number : _____

5 、 Electronic Characteristics of Module :

1.Input Voltage :	☐ Pass	☐ NG , _____
2.Supply Current :	☐ Pass	☐ NG , _____
3.Driving Voltage for LCD :	☐ Pass	☐ NG , _____
4.Contrast for LCD :	☐ Pass	☐ NG , _____
5.B/L Driving Method :	☐ Pass	☐ NG , _____
6.Negative Voltage Output :	☐ Pass	☐ NG , _____
7.Interface Function :	☐ Pass	☐ NG , _____
8.LCD Uniformity :	☐ Pass	☐ NG , _____
9.ESD test :	☐ Pass	☐ NG , _____
10.Others :	☐ Pass	☐ NG , _____

6 、 Summary :
Sales signature : _____

Customer Signature : _____

Date : / /